

Triple 4-3-3-Input Bus Driver

The MC10H123 is a triple 4-3-3-Input Bus Driver.

The MC10H123 consists of three NOR gates designed for bus driving applications on card or between cards. Output low logic levels are specified with $V_{OL} = -2.1$ Vdc so that the bus may be terminated to -2.0 Vdc. The gate output, when low, appears as a high impedance to the bus, because the output emitter-followers of the MC10H123 are "turned-off." This eliminates discontinuities in the characteristic impedance of the bus.

The V_{OH} level is specified when driving a 25-ohm load terminated to -2.0 Vdc, the equivalent of a 50-ohm bus terminated at both ends. Although 25 ohms is the lowest characteristic impedance that can be driven by the MC10H123, higher impedance values may be used with this part. A typical 50-ohm bus is shown in Figure 1.

- Propagation Delay, 1.5 ns Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 0$)	V_{EE}	-8.0 to 0	Vdc
Input Voltage ($V_{CC} = 0$)	V_I	0 to V_{EE}	Vdc
Output Current—Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range— Plastic — Ceramic	T_{stg}	-55 to +150 -55 to +165	°C °C

ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2$ V $\pm 5\%$) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	60	—	56	—	60	mA
Input Current High	I_{inH}	—	495	—	310	—	310	μ A
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	μ A
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
Low Output Voltage	V_{OL}	-2.1	-2.03	-2.1	-2.03	-2.1	-2.03	Vdc
High Input Voltage	V_{IH}	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
Low Input Voltage	V_{IL}	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

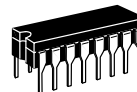
AC PARAMETERS

Propagation Delay	t_{pd}	0.7	1.5	0.7	1.6	0.7	1.7	ns
Rise Time	t_r	0.7	1.6	0.7	1.7	0.7	1.8	ns
Fall Time	t_f	0.7	1.6	0.7	1.7	0.7	1.8	ns

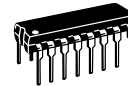
NOTE:

Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.1 volts.

MC10H123



L SUFFIX
CERAMIC PACKAGE
CASE 620-10

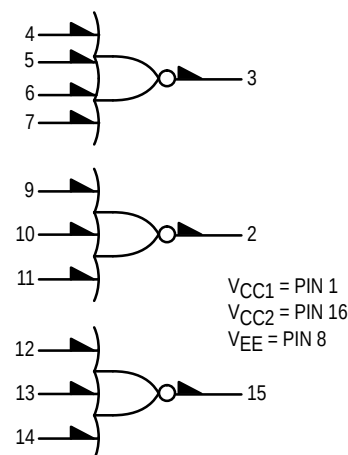


P SUFFIX
PLASTIC PACKAGE
CASE 648-08

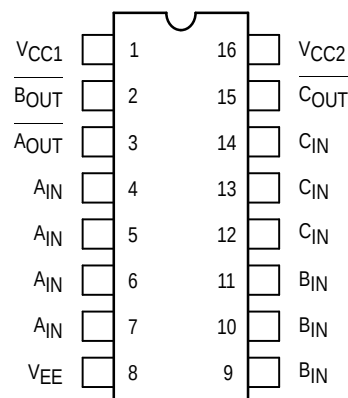


FN SUFFIX
PLCC
CASE 775-02

LOGIC DIAGRAM



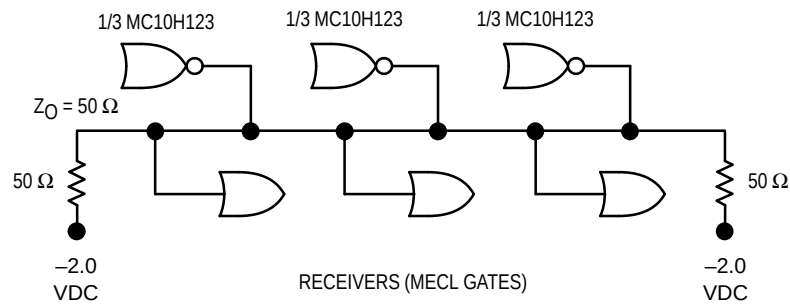
DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion
Tables on page 6-11 of the Motorola MECL Data
Book (DL122/D).

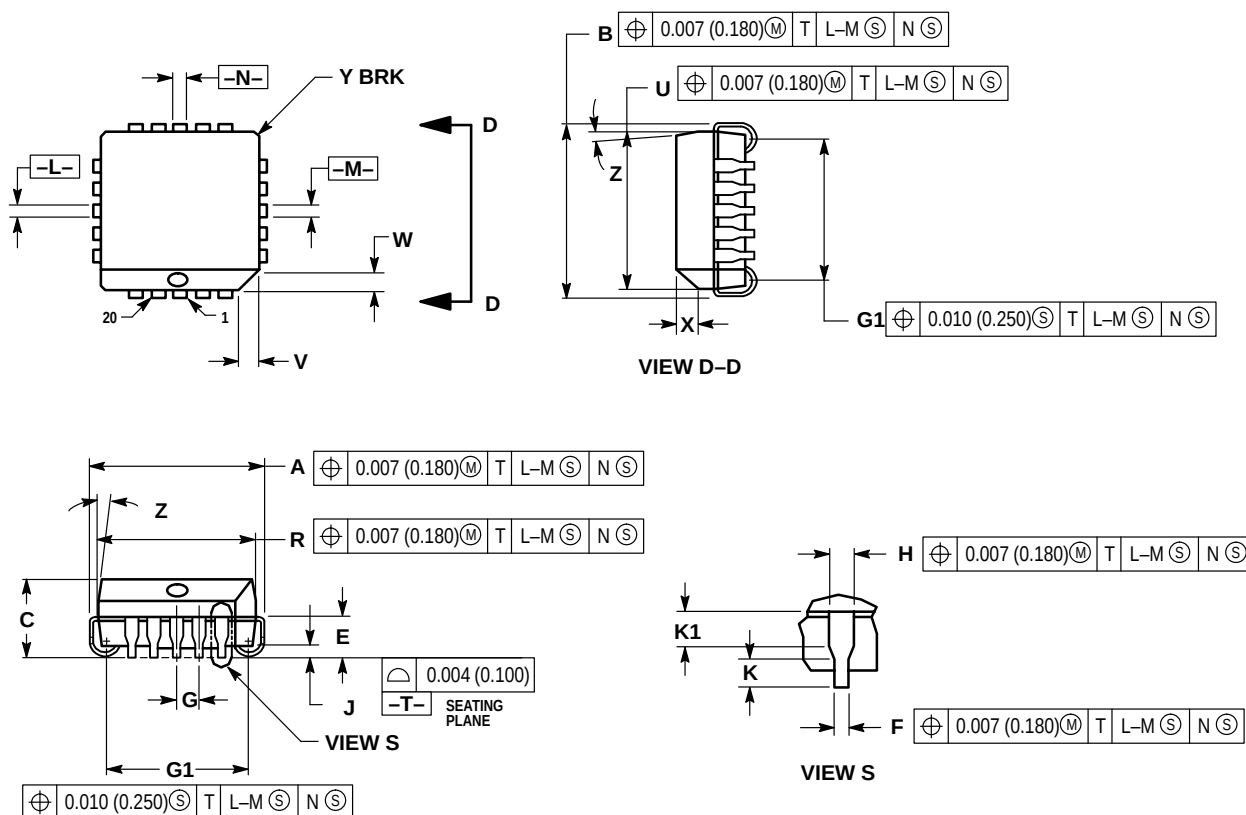


FIGURE 1 — 50-OHM BUS DRIVER (25-OHM LOAD)



OUTLINE DIMENSIONS

FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775-02
ISSUE C

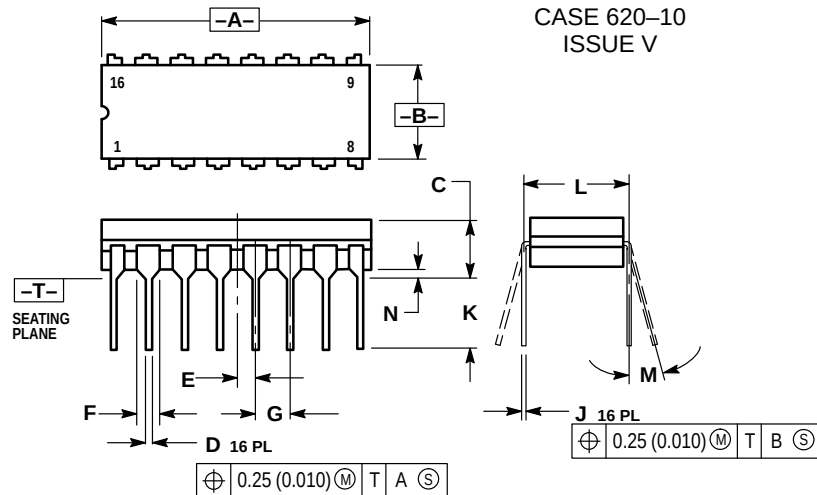


NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	—	1.02	—

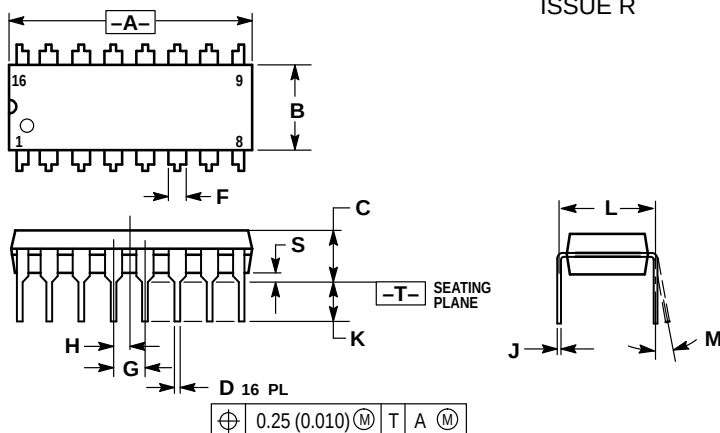
OUTLINE DIMENSIONS

L SUFFIX
 CERAMIC DIP PACKAGE
 CASE 620-10
 ISSUE V


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050	BSC	1.27	BSC
F	0.055	0.065	1.40	1.65
G	0.100	BSC	2.54	BSC
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300	BSC	7.62	BSC
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

P SUFFIX
 PLASTIC DIP PACKAGE
 CASE 648-08
 ISSUE R


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100	BSC	2.54	BSC
H	0.050	BSC	1.27	BSC
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

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